

Low Emission UV resistant

POM copolymer

Product with reduced emissions especially for automotive interior application. Good properties of the standard-injection molding grades like high rigidity, hardness and toughness; good chemical resistance to solvents, fuel and strong alkalis as well as good hydrolysis resistance; high resistance to thermal and oxidative degradation are maintained Burning rate ISO 3795 and FMVSS 302 < 75 mm/min for a thickness more than 1 mm. VDA 275 Emissions < 10 ppm Ranges of applications: automotive engineering,

FMVSS = Federal Motor Vehicle Safety Standard (USA)

Rheological properties

Melt volume-flow rate	8	cm ³ /10min	ISO 1133
Temperature	190	°C	
Load	2.16	kg	
Moulding shrinkage, parallel	2.0	%	ISO 294-4, 2577
Moulding shrinkage, normal	1.8	%	ISO 294-4, 2577

Typical mechanical properties

Tensile Modulus	2850	MPa	ISO 527-1/-2
Yield stress, 50mm/min	64	MPa	ISO 527-1/-2
Yield strain, 50mm/min	9	%	ISO 527-1/-2
Nominal strain at break	30	%	ISO 527-1/-2
Flexural Modulus	2700	MPa	ISO 178
Tensile creep modulus, 1h	2500	MPa	ISO 899-1
Tensile creep modulus, 1000h	1300	MPa	ISO 899-1
Charpy impact strength, 23°C	200 ^[P]	kJ/m²	ISO 179/1eU
Charpy impact strength, -30°C	200	kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C	6.5	kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C	6	kJ/m²	ISO 179/1eA
Ball indentation hardness, H 358/30	144	MPa	ISO 2039-1
[P]: Partial Break			

Thermal properties

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Melting temperature, 10 °C/min	166 °C	ISO 11357-1/-3
Temp. of deflection under load, 1.8 MPa	104 °C	ISO 75-1/-2
Vicat softening temperature, 50°C/h, 50N	150 °C	ISO 306
Coeff. of linear therm. expansion, parallel	110 E-6/K	ISO 11359-1/-2
Coeff. of linear therm. expansion, normal	110 E-6/K	ISO 11359-1/-2
Thermal conductivity of melt	0.155 W/(m K)	Internal
Eff. thermal diffusivity	$4.85E-8 \text{ m}^2/\text{s}$	Internal
Spec. heat capacity of melt	2210 J/(kg K)	Internal

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Internal

HOSTAFORM® C 9021 XAP® LS colored

Electrical properties

Relative permittivity, 100Hz	4	IEC 62631-2-1
Relative permittivity, 1MHz	4	IEC 62631-2-1
Dissipation factor, 100Hz	20 E-4	IEC 62631-2-1
Dissipation factor, 1MHz	50 E-4	IEC 62631-2-1
Volume resistivity	1E12 Ohm.m	IEC 62631-3-1
Surface resistivity	1E14 Ohm	IEC 62631-3-2
Electric strength	35 kV/mm	IEC 60243-1
Comparative tracking index	PLC 0 PLC	UL 746A

Other properties

Humidity absorption, 2mm	0.2 %	Sim. to ISO 62
Water absorption, 2mm	0.65 %	Sim. to ISO 62
Density	1410 kg/m³	ISO 1183
Density of melt	1200 kg/m ³	Internal

Injection

Drying Temperature	120 - 140	°C
Drying Time, Dehumidified Dryer	3 - 4	h
Processing Moisture Content	0.15	%
Screw tangential speed	0.2 - 0.21	m/s
Max. mould temperature	80 - 120	°C
Back pressure	4	MPa
Injection speed	slow-medium	
Ejection temperature	140	°C

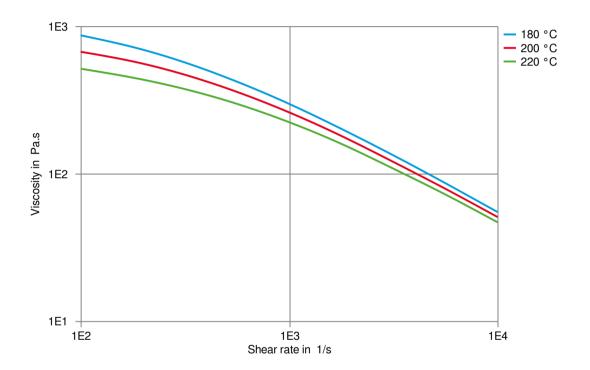
Characteristics

Additives Release agent

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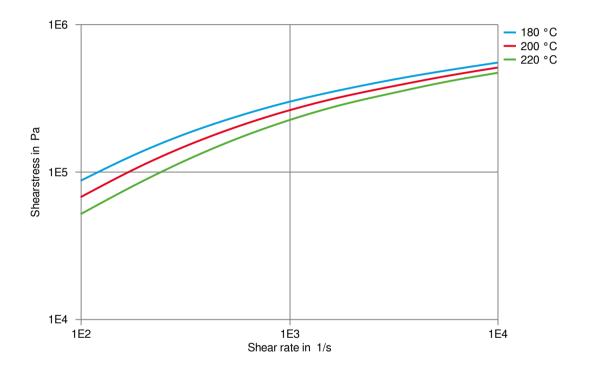
Viscosity-shear rate



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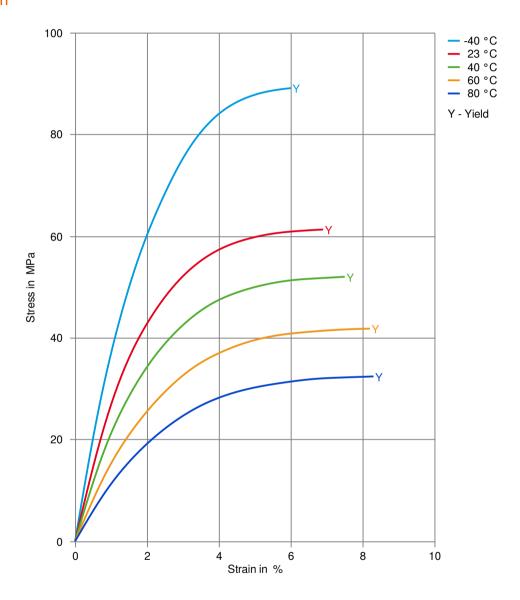
Shearstress-shear rate



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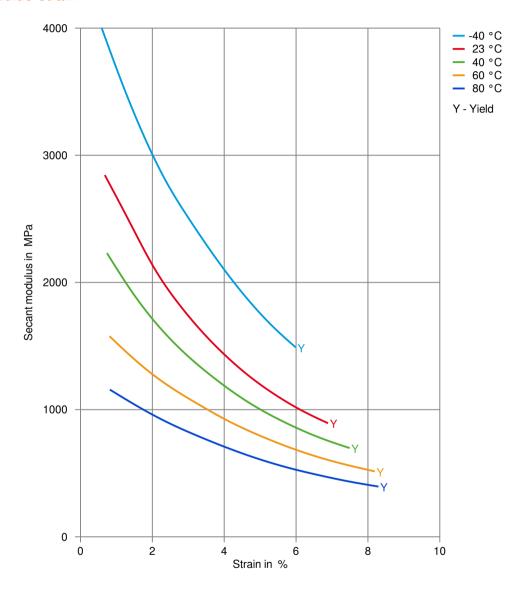
Stress-strain



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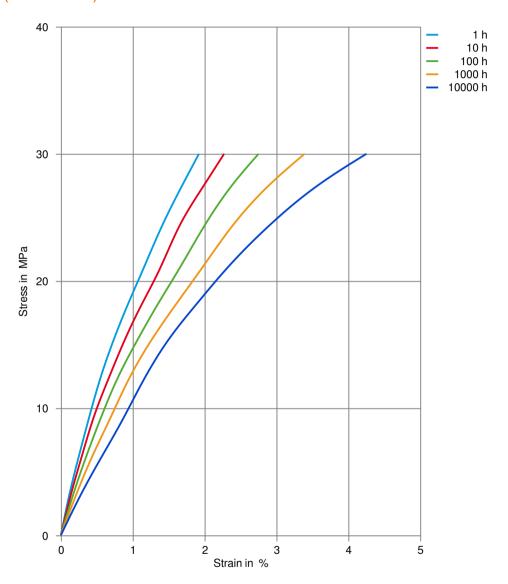
Secant modulus-strain



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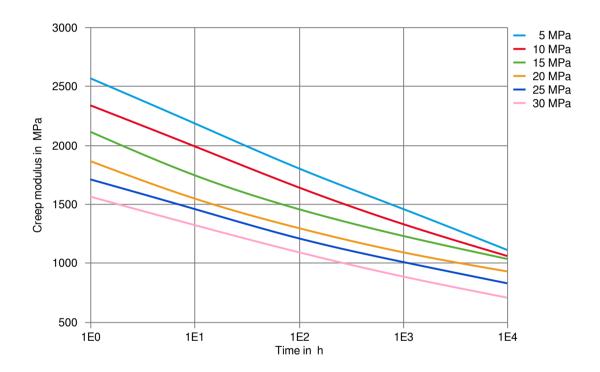
Stress-strain (isochronous) 23°C



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Creep modulus-time 23°C



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Processing Texts

Pre-drying It is normally not necessary to dry HOSTAFORM. However, should there be

surface moisture (condensate) on the molding compound as a result of incorrect storage, drying is required. A circulating air drying cabinet can be used for this

purpose if the granul

Longer pre-drying times/storage The product can then be stored in standard conditions until processed.

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Revised: 2023-02-23 Source: Celanese Materials Database

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